

04-15-2002


**REGISTRATION FORM COVER SHEET
PATENTS ONLY**

4/9/02

U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 06502.0399
Attorney Customer Number: 22,852

**To be
Filed**

102054569

**Identify Trademarks:
Serial or copy thereof.**

ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):
Roberto Chinnici
Rahul Sharma
Phillip B. Goodwin
Douglas C. Kohlert

2. Name and address of receiving party(ies):

Name: Sun Microsystems, Inc.

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Internal Address: MS PAL01 521

3. Nature of conveyance:

Street Address: 901 San Antonio Road

☒ Assignment ☐ Merger

City: Palo Alto

☐ Security Agreement ☐ Change of Name

State: CA Zip Code: 94303

☐ Other:

Additional name(s) & Address(es) attached?

Execution Date: March 18, 2002

☐ Yes ☒ No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: March 18, 2002

A. Patent Application Number(s):

B. Patent Number(s):

10/118153

Additional numbers attached?

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

6. Total number of applications and registrations involved:
One

Name: Jeffrey A. Berkowitz

7. Total fee (37 CFR 3.41): \$40

04/10/2002 MABD11 00000030 10118153

04 FC:581

40.00 DP

☒ Enclosed (Please charge deficiency to deposit account)☐ Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington, D.C.

State: Zip: 20005-3315

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph E. Palys

April 9, 2002

Reg. No. 46, 508

Signature

Date

Total number of pages including cover sheet, attachments and documents: Two

SOLE/JOINT INVENTION
(Worldwide Rights)**ASSIGNMENT**

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

**METHODS, SYSTEMS, AND ARTICLES OF MANUFACTURE FOR PROVIDING AN EXTENSIBLE
SERIALIZATION FRAMEWORK FOR AN XML BASED RPC COMPUTING ENVIRONMENT**

(Title of Invention)

for which I/WE executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on _____, 19 ____ (Serial No. _____); and

WHEREAS, Sun Microsystems, Inc., a corporation of Delaware, United States of America, whose post office address is
(Full Name of Assignee) (Country of Incorporation)

901 San Antonio Road, MS PAL01 521, Palo Alto, CA 94303 [hereinafter referred to as Assignee], is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;



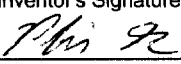
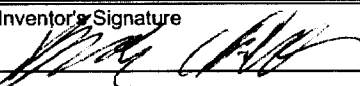
NOW THEREFORE, be it known that for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional application Serial No. _____, filed _____ (if any), and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above provisional application (if any), as well as all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

Full Name of Second Inventor Roberto CHINNICI	Inventor's Signature 	Date 3/18/02
ADDRESS 880 East Fremont Ave #408, Sunnyvale, CA 94087		Citizenship Italian
Full Name of First Inventor Rahul SHARMA	Inventor's Signature 	Date 3/18/02
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Full Name of First Inventor Phillip B. GOODWIN	Inventor's Signature 	Date 3/18/2002
ADDRESS 10237 Will Court Cupertino CA 95014		Citizenship United States
Full Name of Second Inventor Douglas C. KOHLERT	Inventor's Signature 	Date 3/18/02
ADDRESS 7320 CHADWICK ST., GILROY, CA 95020		Citizenship United States

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RECORDED: 04/09/2002

PATENT
REEL: 012778 FRAME: 0227